2SK1869(L), 2SK1869(S)

Silicon N-Channel MOS FET

HITACHI

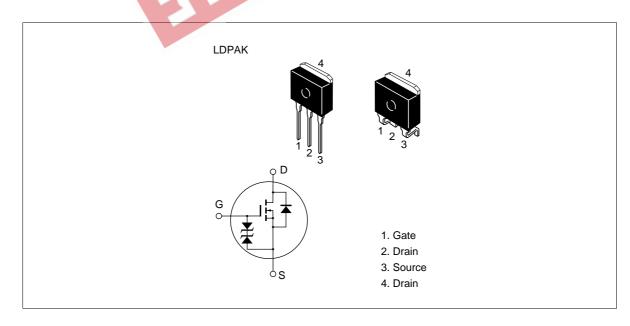
Application

High speed power switching

Features

- Low on-resistance
- High speed switching
- Low drive current
- No Secondary Breakdown
- 逐步^{表现,}Cn Suitable for Switching regulator, DC - DC converter

Outline





2SK1869(L), 2SK1869(S)

Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings	Unit
Drain to source voltage	$V_{\scriptscriptstyle DSS}$	350	V
Gate to source voltage	V_{GSS}	±30	V
Drain current	I _D	7	А
Drain peak current	I _{D(pulse)} *1	28	А
Body to drain diode reverse drain current	I _{DR}	7	А
Channel dissipation	Pch*2	50	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C
2. Value at Tc = 25 °C	N.S.	om.cn	



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Electrical Characteristics ($Ta = 25^{\circ}C$)

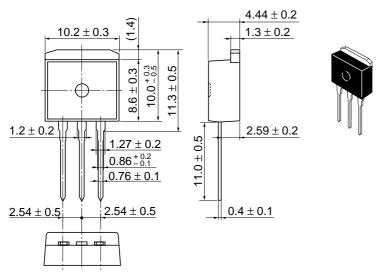
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	350	_	_	V	$I_{D} = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	±30	_	_	V	$I_{G} = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	$I_{\rm GSS}$	_	_	±10	μΑ	$V_{GS} = \pm 25 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}	_	_	250	μΑ	$V_{DS} = 280 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	$V_{\text{GS(off)}}$	2.0	_	3.0	V	$I_D = 1 \text{ mA}, V_{DS} = 10 \text{ V}$
Static drain to source on state resistance	$R_{DS(on)}$	_	0.6	0.8	Ω	$I_D = 4 A$ $V_{GS} = 10 V^{*1}$
Forward transfer admittance	y _{fs}	3.0	5.0	_	S	$I_D = 4 \text{ A}$ $V_{DS} = 10 \text{ V}^{*1}$
Input capacitance	Ciss	_	635	- 35-	pF	V _{DS} = 10 V
Output capacitance	Coss	_	230	女作	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	_	40	J	pF	f = 1 MHz
Turn-on delay time	$\mathbf{t}_{\text{d(on)}}$		10	-0	ns	I _D = 4 A
Rise time	t _r	1 /	50		ns	$V_{GS} = 10 \text{ V}$
Turn-off delay time	$t_{d(off)}$	78	60	_	ns	$R_L = 7.5\Omega$
Fall time	t _f		40	_	ns	
Body to drain diode forward voltage	V_{DF}	_	0.95	_	V	$I_F = 7 \text{ A}, V_{GS} = 0$
Body to drain diode reverse recovery time	t _{rr}	_	240	_	ns	$I_F = 7 \text{ A}, V_{GS} = 0,$ $di_F / dt = 100 \text{ A} / \mu \text{s}$

Note 1. Pulse Test

See characteristic curves of 2SK1400A



Unit: mm



Lita ahi Ca da	LDDAK (L)
Hitachi Code	LDPAK (L)
JEDEC	_
EIAJ	_
Weight (reference value)	1.4 a

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